System power supply for car stereos BA3915B

The BA3915B is a one-chip power supply IC for use in car audio systems. the IC has seven output systems: one 5V output (VDD), four 8.5V outputs (COM, FM, AM, AR), and two high-side switch outputs (ANT, AMP). The 5V outputs operate all the time if only the BCAD input is provided. The other outputs operate with BACKUP and ACC inputs, and their ON/OFF is controlled by the STANDBY and MODE inputs.

Applications

Car audio systems

Features

- ACC and BACKUP voltages are monitored, compared with the internally set values; one-shot pulses are output to MUTE, which synchronizes with the rising and falling of the STANDBY input.
- ACC voltage is monitored, compared with the internally set value, and the result is output to ACCB.
- 3) All outputs use a PNP transistor with low saturation voltage.
- 4) Output current limit circuit prevents damage to the IC due to short-circuiting.
- Overvoltage protection circuit provides protection against surges from the ACC or BACKUP input.
- Compact 16-pin POWER package allows large power dissipation.

●Absolute maximum ratings (Ta=25°C)

Parameter	Symbol	Limits	Unit V	
Power supply voltage	BACKUP/ACC	24		
Power dissipation	Pd	3400	mW	
Operating temperature	Topr	-30~85	ొ	
Storage temperature	Tstg	− 55~150	C	
Peak applied voltage	BACKUP/BCAP/ACC Peak	50*1	٧	

^{*1} tr \geq 1 msec, applied time is less than 200 msec

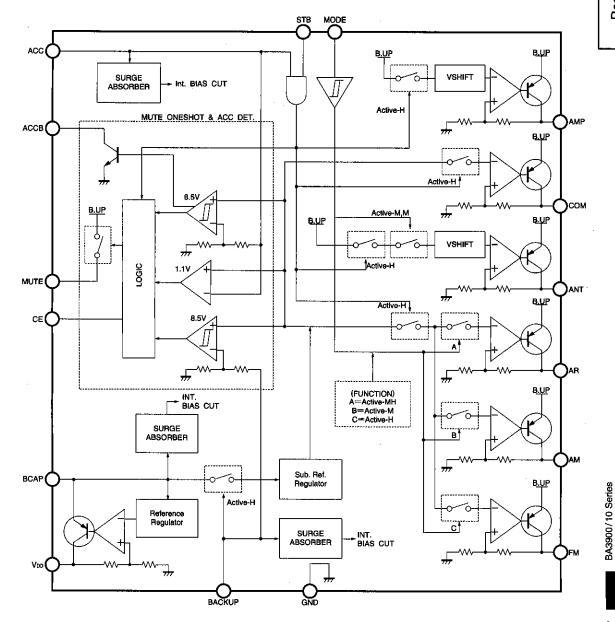
● Recommended operating conditions (Ta=25°C)

Parameter	Symbol	Min.	Тур.	Мах.	Unit	
Recommended power supply voltage	BACKUP/BCAP/ACC	10	13.2	16		
Operable voltage	BACKUP/BCAP/ACC	9.6	13.2	24	٧	
MUTE section operating voltage	BACKUP	4.0	_	_	V	

Note: Not Intended to ensure electrical characteristics (in particular, during a voltage drop)

Note: When the BACKUP input voltage becomes less than about 3 V, all the outputs except

VDD are shut down together with the logic bias voltage.

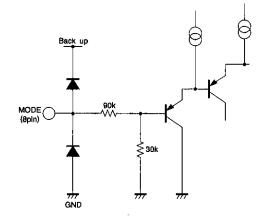


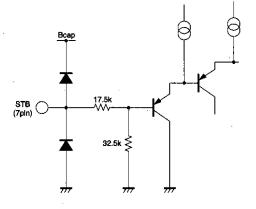
n Power Supply

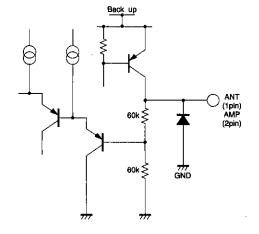
●Pin description (Ta=25°C, BACKUP/ACC=13.2V)

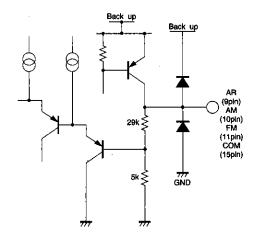
Pin No.	Pin name	Function
1	ANT	12.6 V power supply output pin for antenna drive
2	AMP	12.6 V power supply output pin for amplifiers
3	Voo	5.0 V power supply output pin for microcontroller; always output when BACKUP input is provided
4	MUTE	One-shot pulse output pin
5	CE	Capacitor connection pin for one-shot pulse time constant (TM) setting
6	ACCB	NPN transistor open collector output; ON when ACC is 8.5 V (typical) or more
7	STANDBY	Only Vpb is output when LOW; COM, FM, AM, AR, ANT, and AMP can be output when HIGH
8	MODE	3-mode input controls ON/OFF of FM, AM, AR, ANT, and AMP outputs
9	AR	8.5 V power supply output pin for AR
10	AM	8.5 V power supply output pin for AM tuner
11	FM	8.5 V power supply output pin for FM tuner
12	ACC	Accessory power supply connection pin
13	BCAP	Capacitor connection pin for Vob backup
14	BACKUP	Backup power supply connection pin
15	COM	8.5 V power supply output pin for COMMON
16	GND	Ground pin

●Input/output circuits



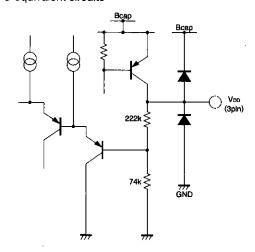


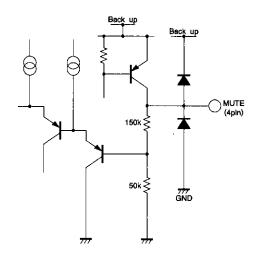


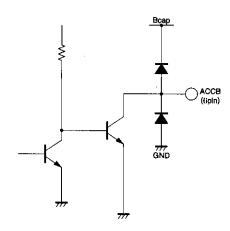


225

I/O equivalent circuits







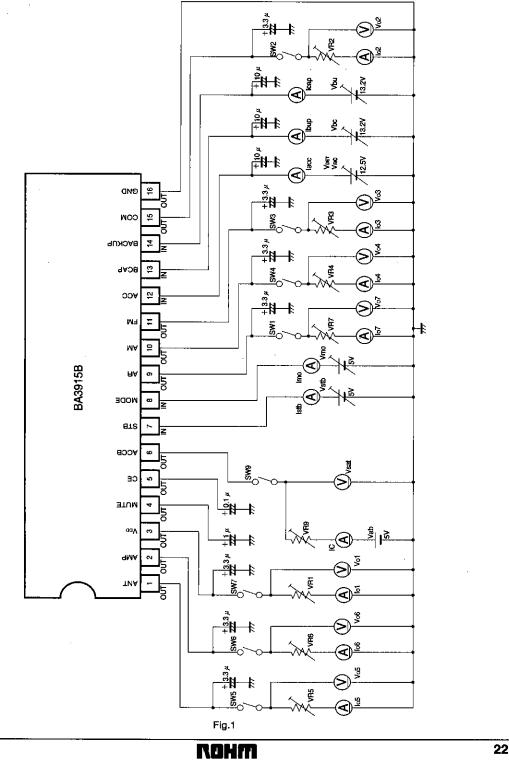
●Electrical characteristics (unless otherwise noted, Ta=25°C, BACKUP/ACC=13.2V)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions	Measurement Circuit
BCAP circuit current 1	CAP1	_	0.40	0.55	mA	BCAP=12.5V, BUP=0V	1
BACKUP standby circuit current	laup	-	0.18	0.20	mA	BUP=13.2V, BCAP=12.5V	1
BCAP circuit current 2	ICAP2	_	1.30	1.75	mA	BUP=13.2V, BCAP=12.5V	1
[V _{DD}]						1.01	
Output voltage	V01	4.75	5.00	5.25	٧	lo1=80mA	1
Voltage variation	△V ₀₁₁	ı	100	300	m∨	lo1=80mA	1
Load variation	V ₀₁₁	ļ	50	170	m∨	lo1; 0→80mA	1
Minimum I/O voltage differential	△V ₀₁₂	_	0.4	0.7	٧	Io1=80mA	1
Output current capacity	lo ₁	80	_	_	mA		1
Ripple rejection ratio	RR1	41	45	_	dB	f=100Hz, VRR=-10dBV	2
[COM]							
Output voltage	V ₀₂	8.05	8.50	8.95	٧	lo2=300mA	1
Voltage variation	△V021	-	100	300	mV	lo2=300mA	1
Load variation	V ₀₂₁	-	50	170	mV	lo₂; 0→300mA	1
Minimum I/O voltage differential	△V022	_	0.4	0.7	٧	lo2=300mA	1
Output current capacity	lo ₂	300			mA		1
Ripple rejection ratio	RR2	41	45		dB	f=100Hz, V _{RR} =-10dBV	2
(FM)							
Output voltage	Vos	8.05	8.50	8.95	٧	lo₃=300mA	1
Voltage variation	△V031	-	100	300	mV	103=300mA	1
Load variation	V031	_	50	170	m۷	lo₃ ; 0→300mA	1
Minimum I/O voltage differential	△V032		0.4	0.7	mV	l∞=300mA	1
Output current capacity	103	300	_	_	mA		1
Ripple rejection ratio	RR3	41	45	_	dB	f=100Hz, VRA=-10dBV	2
[AM]							
Output voltage	V ₀₄	8.05	8.50	8.95	٧	lo4=200mA	1
Voltage variation	△V041	_	100	300	mV	lo4=200mA	1
Load variation	V041	_	50	170	mV	lo₄; 0→200mA	1
Minimum I/O voltage differential	△V042	_	0.4	0.7	ν	lo4=200mA	1
Output current capacity	l ₀₄	200			mA		1
Ripple rejection ratio	RR4	36	40	_	dB	f=100Hz, Var=-10dBV	2
[ANT]							
Minimum I/O voltage differential	△V052		0.6	1.1	٧	lo5=250mA	1
Load variation	V ₀₅₁	_	180	540	mV	lo₅ ; 0→250mA	1
Output current capacity	106	250	_	_	mA		1
[AMP]							
Minimum I/O voltage differential	△V ₀₈₂	_	0.6	1.1	V	loe=100mA	1
Load variation	V061	_	100	300	mV	los; 0→100mA	1
Output current capacity	los	100			mA		1

●Electrical characteristics (unless otherwise noted, Ta=25°C, BACKUP/ACC=13.2V)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions	Measurement Circuit
[AR]							
Output voltage	V07	8.05	8.50	8.95	٧	lo7=200mA	1
Voltage variation	△V071	_	100	300	mV	Io7=200mA	1
Load variation	V071		50	170	mV	lor; 0→200mA	1
Minimum I/O voltage differential	△V072	-	0.4	0.7	٧	lo7=200mA	1
Output current capacity	lo ₇	200			mA		1
Ripple rejection ratio	RR7	41	45	_	dB	f=100Hz, V _{RR} =-10dBV	2
[MUTE]							
Output voltage	Vos	4.3	4.9	5.5	٧	los=10mA	3
Pulse CE output current	Ітм	0.6	1.0	1.4	μΑ	Ioe=10mA	3
Pulse threshold voltage	VtM	0.9	1.0	1.1	٧	loe=10mA	3
Pulse width	TM	_	0.1	_	SEC	CE=0.1 μF	3
(ACC)							
Output A rising threshold	VTAR1	1.0	1.1	1.2	٧	TM is counted from ACC = VTAR2	3
Pulse A rising threshold	VTAH2	8.0	8.5	9.0	٧		3
Output A falling threshold	VTAF1	8.0	8.5	9.0	٧		3
Pulse A falling threshold	VTAF2	1.0	1,1	1.2	٧		3
(BACKUP)							
Output B rising threshold	V _{TBR1}	4.7	5.0	5.3	٧		3
Pulse B rising threshold	V _{TBR2}	8.0	8.5	9.0	٧		3
Output B falling threshold	V18F1	8.0	8.5	9.0	٧		3
Pulse B falling threshold	VTBF2	4.7	5.0	5.3	٧		3
(STANDBY)							
Output S rising threshold	VtsR1	1.6	1.9	2.2	٧		3
Pulse S rising threshold	V _{TSR2}	2.6	2.9	3.2	٧		3
Output S falling threshold	VTSF1	2.6	2.9	3.2	٧		3
Pulse S falling threshold	VTSF2	1.6	1.9	2.2	٧		3
[MODE]							
OFF mode threshold	VTR1	_	_	1.1	٧	OFF MODE	1
AM ON threshold	V _{TR2}	1.25	1.5	1.75	٧	AM MODE WITH ANT, AMP & AR	1
FM ON threshold	VTR3	2.5	3.0	3.5	٧	FM MODE WITH ANT, AMP & AR	1
AM hysteresis width	VAHY	0.1	0.2	0.3	٧	AM MODE WITH ANT, AMP & AR	1
FM hysteresis width	VFHY	0.1	0.2	0.3	٧	FM MODE WITH ANT, AMP & AR	1
Input current	Імо	15	40	65	μΑ	MODE=5V	1
[STANDBY]							
Standby voltage	Vse ₁		-	2.4	٧		1
Active voltage	VsB2	3.2	_		٧		1
Input current	Vsтв	75	100	125	μА	STANDBY=5V	1
[ACCB]							
Detected voltage	VDET	8.0	8.5	9.0	٧	Same as VTAF	1
Output saturation voltage when ON	Vsat1	_	0.5	0.9	٧	ACC=13.2V lo9=2mA	1

Measurement circuit



229

BA3900/10 Series

System Power Supply

Regulator ICs BA3915B

Measurement circuit

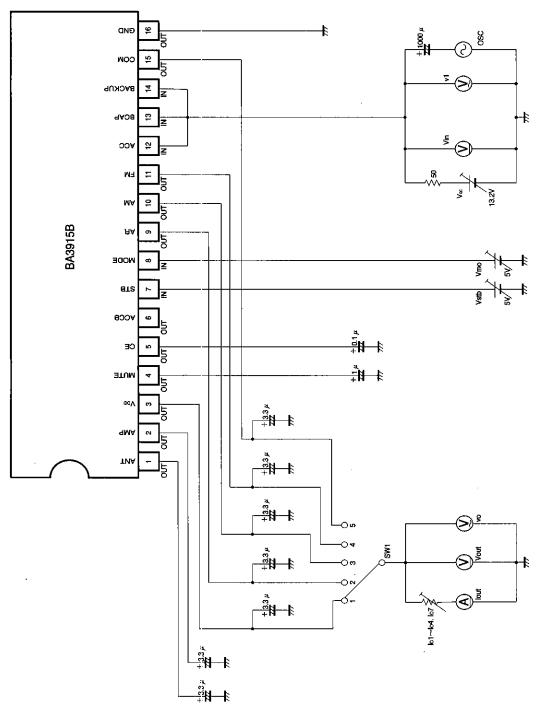
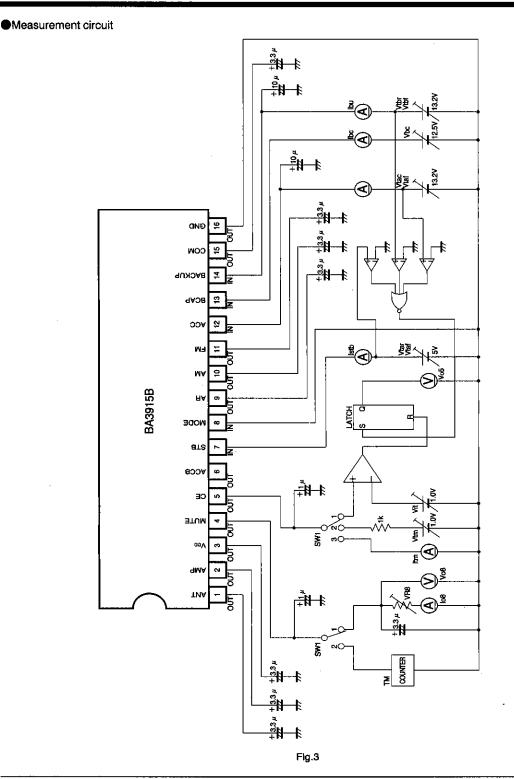
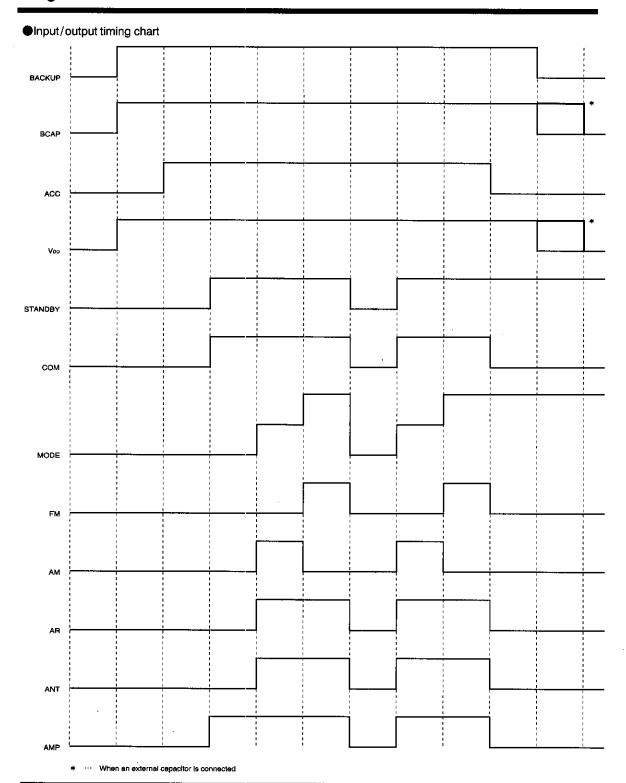
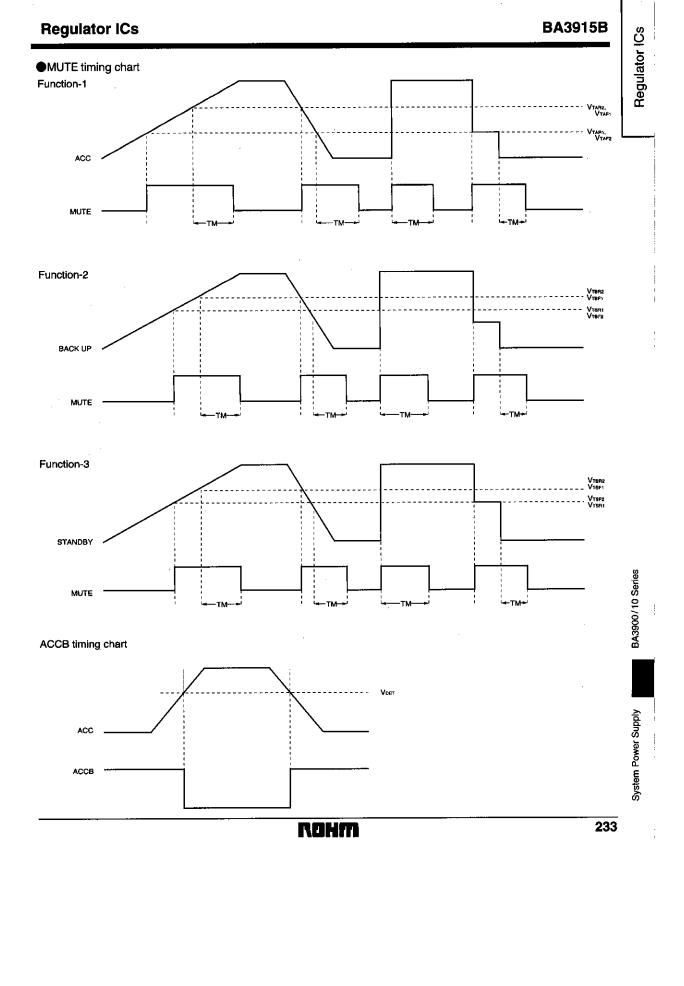


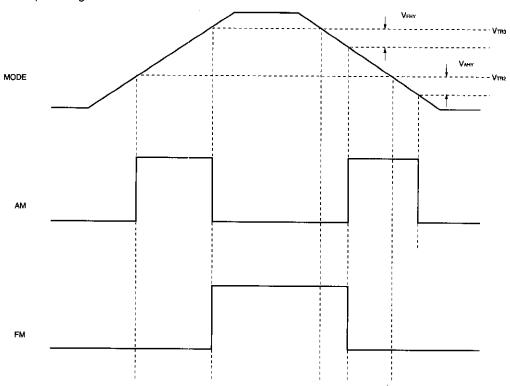
Fig.2





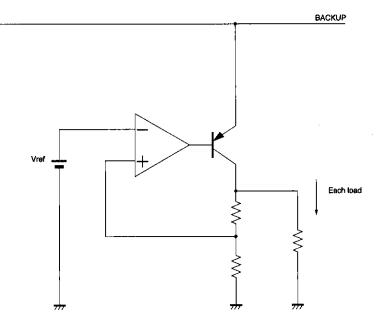


●AM/FM output timing chart



Rough estimation of IC power dissipation

Except under transitional conditions, the power dissipation of this IC is 3.4W per unit at 25°C. See Fig. 4 for heat reduction characteristics, including some cases where heat sinks are used.



A = maximum BACKUP voltage

B = maximum BCAP voltage

 $I_1 = maximum output current for V_{DD} (80mA)$

I₂ = maximum output current for COM (300mA)

I₃ = maximum output current for FM (300mA)

I₄ = maximum output current for AM (200mA)

I₅ = maximum output current for AR (200mA)

I₆ = maximum output current for ANT (250mA)

I₇ = maximum output current for AMP (100mA)

- Power consumed by V_{DD} 5.0V P₁ = (B 5.0V) \times I₁ + (I₁/16 + I₁/10) \times B
- Power consumed by COM 8.5V P₂ = $(A 8.5V) \times I_2 + (I_2/60 + I_2/10) \times A$
- Power consumed by FM 8.5V P₃ = $(A 8.5V) \times I_3 + (I_3/60 + I_3/10) \times A$
- Power consumed by AM 8.5V P₄ = $(A 8.5V) \times I_4 + (I_4/40 + I_4/10) \times A$
- Power consumed by AR 8.5V P₅ = (A 8.5V) \times I₅ + (I₅/40 + I₅/10) \times A
- Power consumed by ANT P₆ = $(0.6V) \times I_6 + (I_6/50 + I_6/10) \times A$
- Power consumed by AMP P₇ = $(0.6V) \times I_7 + (I_7/50 + I_7/10) \times A$
- · Power consumed internally by each circuit P₂ = A × circuit current (about 10mA)

 $P_{MAX} = P_1 + P_2 + (P_3 \text{ or } P_4, \text{ whichever is larger}) + P_5 + P_6 + P_7 + P_8$

Operation notes

(1) Although the quality of this IC is rigorously controlled, the IC may be destroyed when the supply voltage or the operating temperature exceeds their absolute maximum ratings. Because short mode or open mode cannot be specified when the IC is destroyed, be sure to take physical safety measures, such as fusing, if any of the absolute maximum ratings might be exceeded.

(2) Application circuit

The application circuit is recommended for use. Make sure to confirm the adequacy of parts characteristics. When using the circuit with changes to external circuit constants, make sure to leave sufficient margins in consideration of fluctuations in the IC and external components including static and transitional characteristics. Note that ROHM has not carried out extensive survey regarding the patent right of this application.

(3) Operating power supply

When operating within the proper ranges of power supply voltage and ambient temperature, most circuit functions are guaranteed. Although the rated values of electrical characteristics cannot be absolutely guaranteed, characteristic values do not change drastically within the proper ranges.

(4) Power dissipation (Pd)

Refer to the power dissipation characteristics (Fig. 4) and the rough estimation of IC power dissipation given on a separate page. Make sure your design allows the maximum required power within the operating temperature range.

(5) Overvoltage protection circuit

The overvoltage protection circuit turns OFF all outputs when the potential difference between BACKUP (pin 14), BCAP (pin 13), or ACC (pin 12) and GND (pin 16) is more than about 26V at normal temperature. Make sure to use the IC within this voltage limit.

(6) Preventing oscillation at each output

To stop output oscillation, make sure to connect a capacitor having a capacitance of 10 μ F or greater between GND and each of the ANT (pin 1), AMP (pin 2), V_{DD} (pin 3), AM (pin 10), FM (pin 11), and COM (pin 15) output pins. We recommend using a tantalum electrolytic capacitor whose capacitance is unsusceptible to

temperature.

(7) Overcurrent protection circuit

An overcurrent protection circuit is installed on the ANT (pin 1), AMP (pin 2), V_{DD} (pin 3), AM (pin 10), FM (pin 11), and COM (pin 15) outputs, based on the respective output current. This prevents IC destruction due to overcurrent, by limiting the current with a curve shape of "7" in the voltage-current graph. The IC is designed with margins so that current flow will be restricted and latching will be prevented even if a large current suddenly flows through a large capacitor. The circuit should be carefully set because output current is further restricted when output voltage is less than $1V_F$ (considered as short mode).

(8) Thermal protection circuit

A built-in thermal protection circuit prevents thermal damage to the IC. All outputs except V_{DD} are switched OFF when the circuit operates, and revert to the original state when the temperature drops to a certain level.

(9) BACKUP-ACC potential difference

If the BACKUP voltage exceeds the ACC voltage, a current flows through a protection diode connected internally between BACKUP and ACC. If the potential difference is more than 1V_F, this diode is fully turned on.

(10) BCAP pin external diode

Voltage is supplied to BCAP from BACKUP through an external diode. The maximum current consumption is about 100mA. A reverse bias will be applied to the diode if the BACKUP pin becomes 0V. Select a diode that has sufficient electrical characteristics to cope with the above conditions.

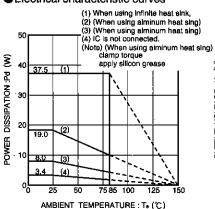
(11) Grounding

Each ground trace in the application circuit must be adequately short from GND (pin 16). Make sure to arrange the ground traces in a pattern that prevents mutual interference.

(12) We recommend installing a bypass line in your application if there is a mode where potential difference between each output and input (Vcc) or GND is reversed from the normal state.

Fig.4

Electrical characteristic curves



AMBIENT TEMPERATURE: To (°C)

4 Temperature dependence of power dissipation

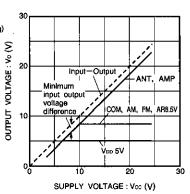


Fig.5 Relationship between output

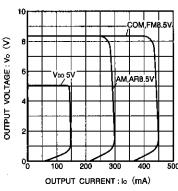


Fig.6 Relationship between output voltage and output current

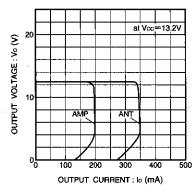


Fig.7 Relationship between output voltage and output current

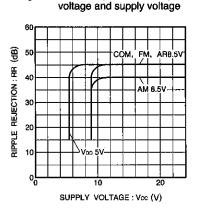
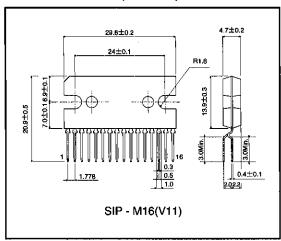


Fig.8 Relationship between the ripple rejection ratio and supply voltage

●External dimensions (Units: mm)



Notes

- The contents described in this catalogue are correct as of March 1997.
- No unauthorized transmission or reproduction of this book, either in whole or in part, is permitted.
- The contents of this book are subject to change without notice. Always verify before use that the contents are the latest specifications. If, by any chance, a defect should arise in the equipment as a result of use without verification of the specifications, ROHM CO., LTD., can bear no responsibility whatsoever.
- Application circuit diagrams and circuit constants contained in this data book are shown as examples of standard use and operation. When designing for mass production, please pay careful attention to peripheral conditions.
- Any and all data, including, but not limited to application circuit diagrams, information, and various data, described in this catalogue are intended only as illustrations of such devices and not as the specifications for such devices. ROHM CO., LTD., disclaims any warranty that any use of such device shall be free from infringement of any third party's intellectual property rights or other proprietary rights, and further, assumes absolutely no liability in the event of any such infringement, or arising from or connected with or related to the use of such devices.
- Upon the sale of any such devices; other than for the buyer's right to use such devices itself, resell or otherwise dispose of the same; no express or implied right or license to practice or commercially exploit any intellectual property rights or other proprietary rights owned or controlled by ROHM CO., LTD., is granted to any such buyer.
- The products in this manual are manufactured with silicon as the main material.
- The products in this manual are not of radiation resistant design.

The products listed in this catalogue are designed to be used with ordinary electronic equipment or devices (such as audio-visual equipment, office-automation equipment, communications devices, electrical appliances, and electronic toys). Should you intend to use these products with equipment or devices which require an extremely high level of reliability and the malfunction of which would directly endanger human life (such as medical instruments, transportation equipment, aerospace machinery, nuclear-reactor controllers, fuel controllers, or other safety devices) please be sure to consult with our sales representatives in advance.

Notes when exporting

- It is essential to obtain export permission when exporting any of the above products when it falls under the category of strategic material (or labor) as determined by foreign exchange or foreign trade control laws.
- Please be sure to consult with our sales representatives to ascertain whether any product is classified as a strategic material.